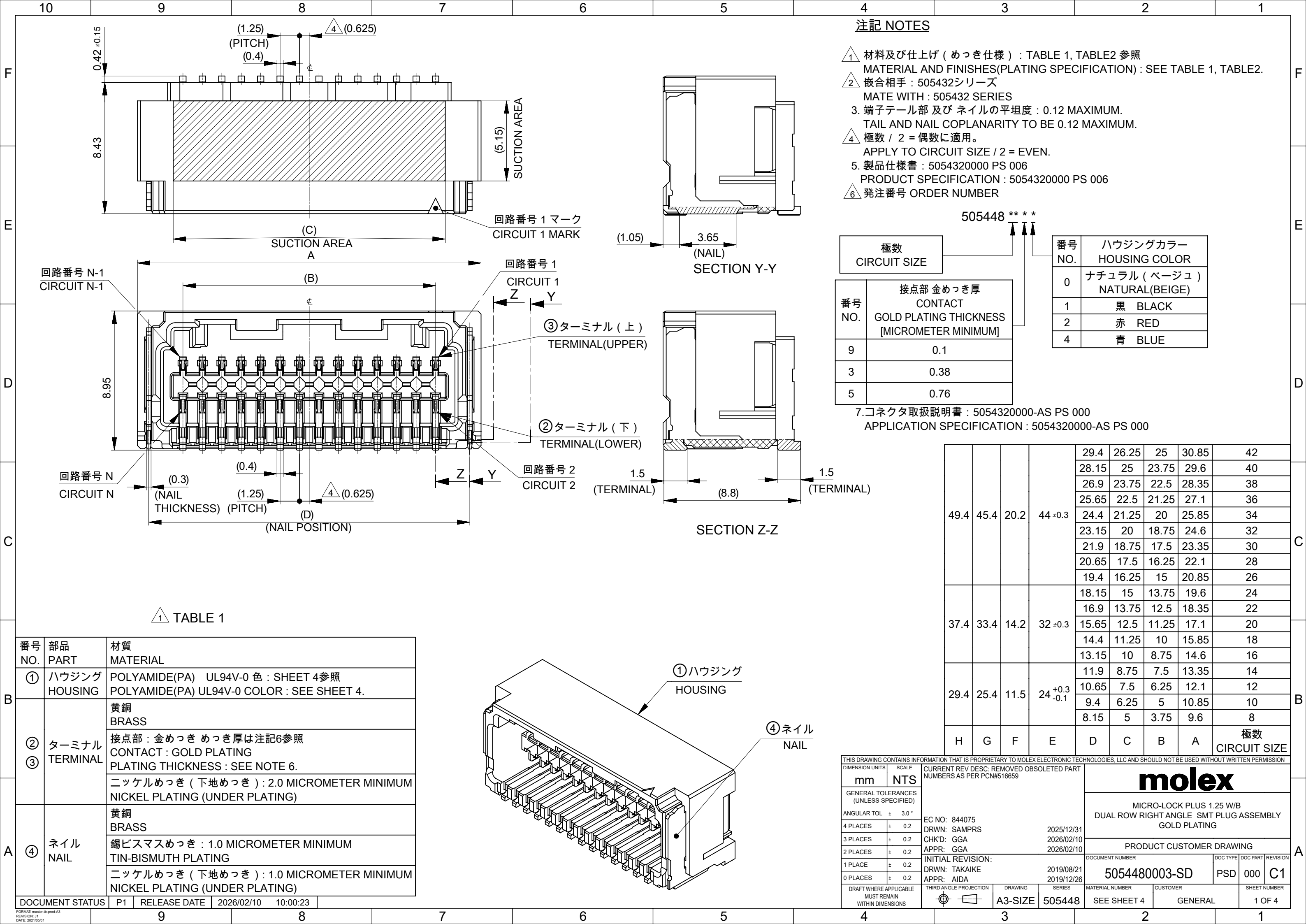
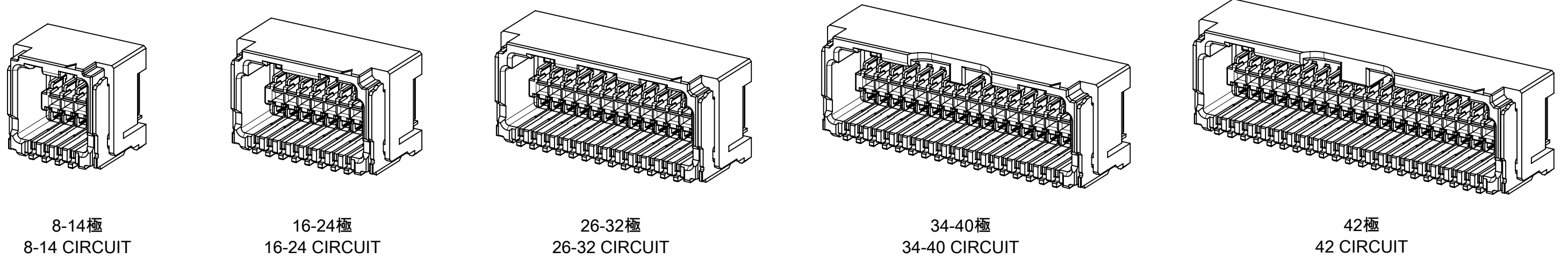
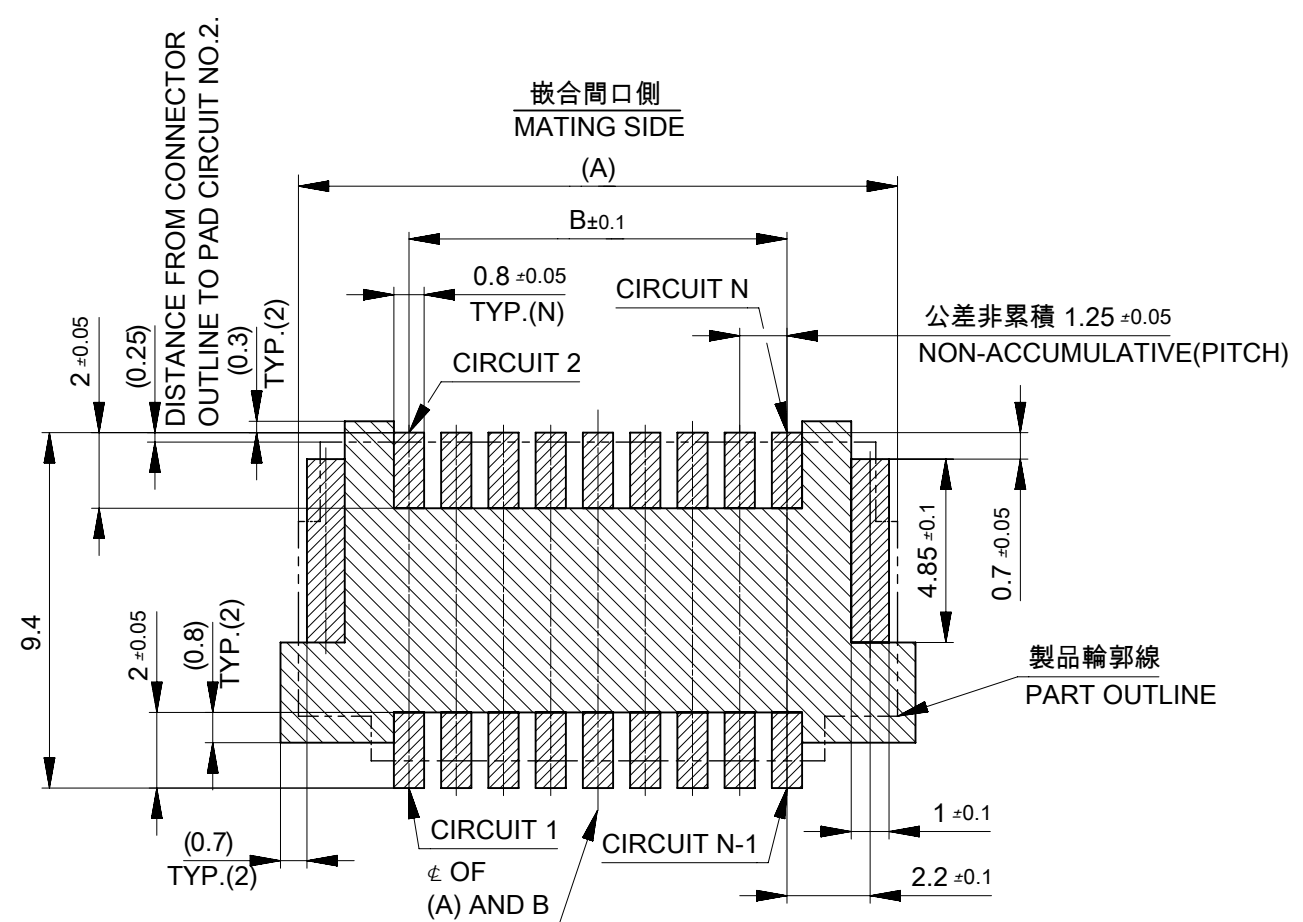
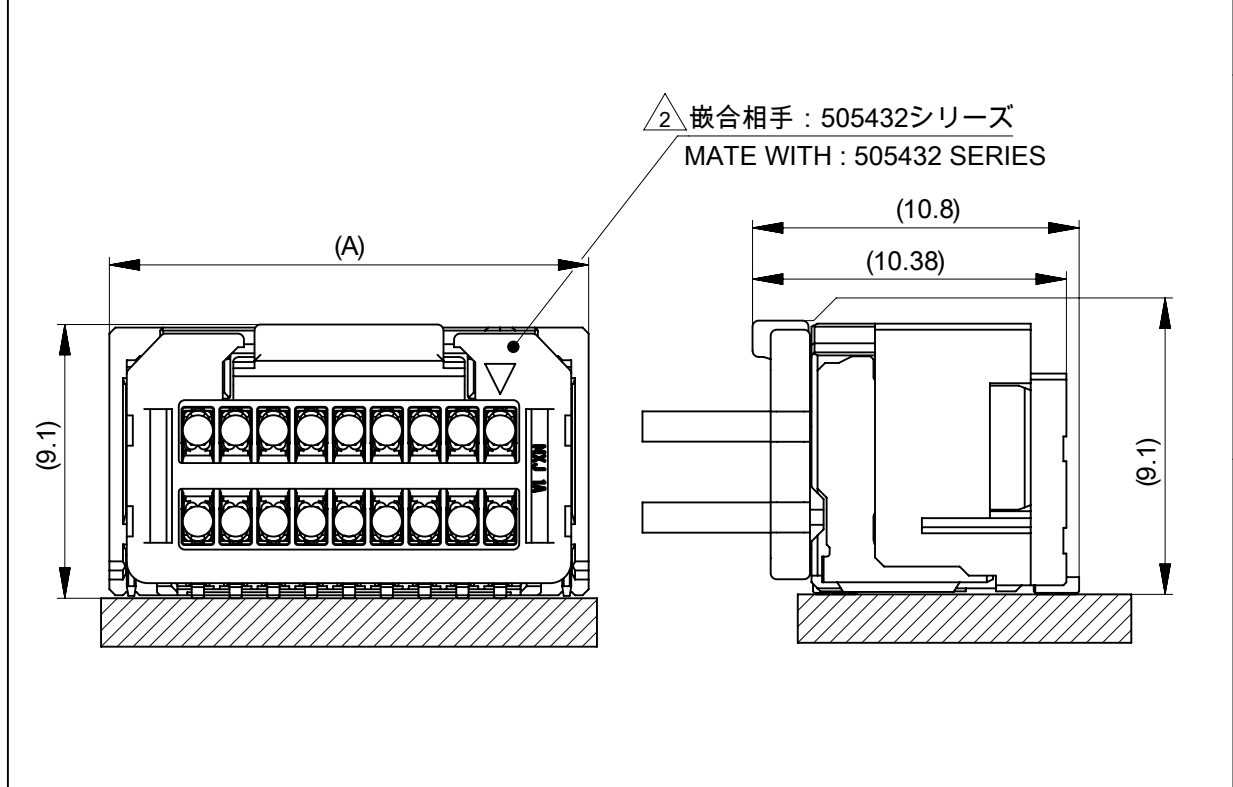




製品形状
PRODUCT SHAPE



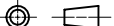
嵌合状態図
MATED CONNECTORS



基板パターンレイアウト (参考)
(参考: 基板厚 1.6mm, メタルマスク厚さ 0.15mm, マスク開口率 100%)

RECOMMEND PCB LAYOUT : COMPONENT SIDE
(REFERENCE : PCB THICKNESS 1.6mm, STENCIL THICKNESS 0.15mm, APERTURE RATIO 100%)

パターン非推奨エリア
パターンを引き回す際は、製品機能に影響がないことをご確認ください。
PATTERN IS NOT RECOMMENDED ON THE HATCHING AREA
PLEASE CHECK NOT TO HAVE PROBLEM FOR PRODUCT FUNCTION
WHEN SETTING PATTERN ON THE HATCHING AREA.

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION												
DIMENSION UNITS		SCALE		CURRENT REV DESC: REMOVED OBSOLETE PART NUMBERS AS PER PCN#516659			mo lex MICRO-LOCK PLUS 1.25 W/B DUAL ROW RIGHT ANGLE SMT PLUG ASSEMBLY GOLD PLATING PRODUCT CUSTOMER DRAWING					
mm		NTS										
GENERAL TOLERANCES (UNLESS SPECIFIED)												
ANGULAR TOL		± 3.0 °										
4 PLACES		± 0.2										
3 PLACES		± 0.2		EC NO: 844075			2025/12/31					
2 PLACES		± 0.2		DRWN: SAMPRS			2026/02/10					
1 PLACE		± 0.2		CHK'D: GGA			2026/02/10					
0 PLACES		± 0.2		APPR: GGA			2026/02/10					
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIRD ANGLE PROJECTION 			INITIAL REVISION:			DOCUMENT NUMBER		DOC TYPE	DOC PART	REVISION
					DRWN: TAKAIKE			5054480003-SD		PSD	000	C1
					APPR: AIDA			2019/08/21		2019/12/26		
DRAWING		SERIES		MATERIAL NUMBER		CUSTOMER			SHEET NUMBER			
A3-SIZE		505448		SEE SHEET 4		GENERAL			2 OF 4			

DOCUMENT STATUS	P1	RELEASE DATE	2026/02/10	10:00:23
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